



DMT32M5LPS

30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	BV _{DSS} R _{DS(ON)} I _L T _C = 4	
2017	2.0mΩ @ V _{GS} = 10V	150A
30V	3.0mΩ @ V _{GS} = 4.5V	100A

Description and Applications

This new generation MOSFET is designed to minimize $R_{DS(ON)}$, yet maintain superior switching performance. This device is ideal for use in power management and load switch.

- DC-DC Converters
- Load Switch

Features

- Thermally Efficient Package-Cooler Running Applications
- <1.1mm Package Profile Ideal for Thin Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

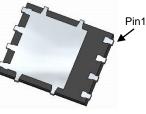
Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

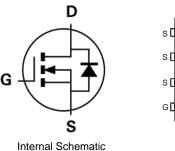


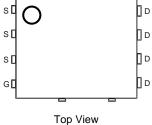
PowerDI5060-8

Top View



Bottom View





Pin Configuration

Ordering Information (Note 4)

Part Number	Case Packaging	
DMT32M5LPS-13	PowerDI5060-8	2,500 / Tape & Reel

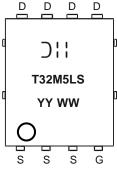
Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking T32M5LS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 19 = 2019) WW = Week (01 to 53)

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Maximum Ratings ($@T_C = +25^{\circ}C$, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	ID	150 120	А		
Maximum Continuous Body Diode Forward Current (Note 6)			Is	80	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	350	A
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			I _{SM}	350	A
Avalanche Current, L = 0.1mH			IAS	50	A
Avalanche Energy, L = 0.1mH			E _{AS}	140	mJ

Thermal Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3.2	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{ heta JA}$	54	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	PD	100	W
Thermal Resistance, Junction to Case (Note 6)		R _θ JC	1.5	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

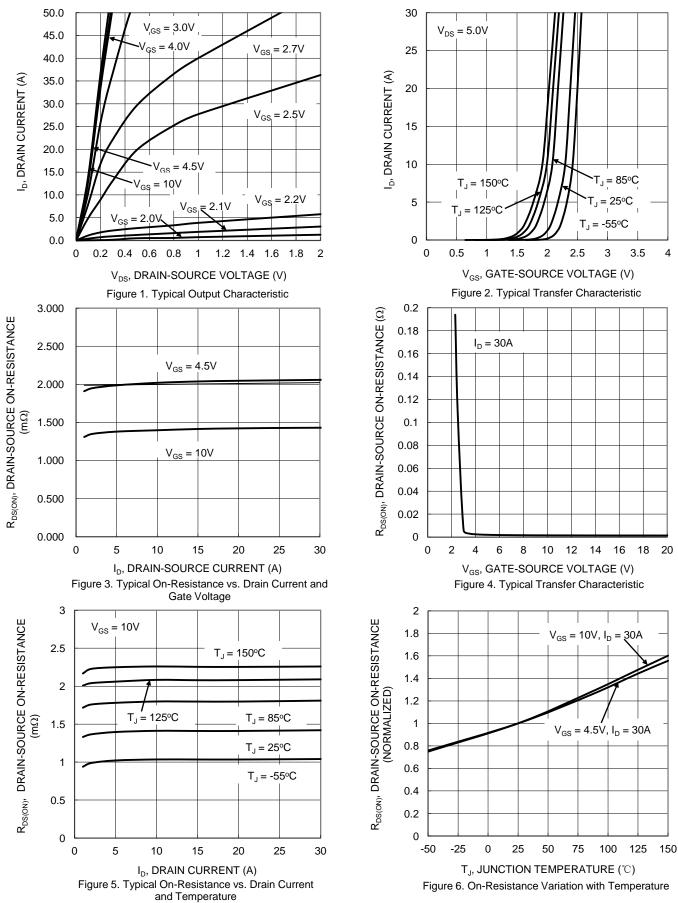
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	Cjb Cl		. 76		•		
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1	—	3	V	$V_{DS} = V_{GS}, I_D = 1mA$	
Static Drain-Source On-Resistance		_	1.6	2.0	mΩ	$V_{GS} = 10V, I_D = 30A$	
	R _{DS(ON)}	_	2.3	3.0	11122	$V_{GS} = 4.5V, I_D = 30A$	
Diode Forward Voltage	V _{SD}	_	0.8	1.1	V	$V_{GS} = 0V, I_{S} = 30A$	
DYNAMIC CHARACTERISTICS (Note 8)						-	
Input Capacitance	C _{iss}	—	3944	_		$V_{DS} = 25V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss	—	1267	—	pF		
Reverse Transfer Capacitance	Crss	—	186	_			
Gate Resistance	R _g	_	0.6	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	34	_		V _{DS} = 15V, I _D = 20A	
Total Gate Charge (V _{GS} = 10V)	Qg	_	68	—	nC		
Gate-Source Charge	Q _{gs}	_	8	—	nc		
Gate-Drain Charge	Q _{gd}	_	15	—			
Turn-On Delay Time	t _{D(ON)}	_	7.2	_		$V_{DD} = 15V, V_{GS} = 10V,$ $I_D = 15A, R_G = 3\Omega$	
Turn-On Rise Time	t _R	_	13.2	_			
Turn-Off Delay Time	t _{D(OFF)}	_	37.5	_	ns		
Turn-Off Fall Time	t _F	_	23.9	—			
Body Diode Reverse Recovery Time	t _{RR}	_	28.7	_	ns		
Body Diode Reverse Recovery Charge	Q _{RR}	_	45.8	—	nC	- I _S = 15Α, di/dt = 500Α/μs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect. Notes:

8. Guaranteed by design. Not subject to production testing.

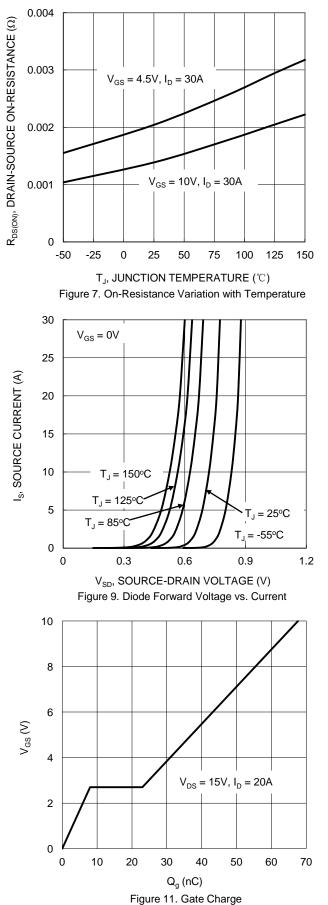


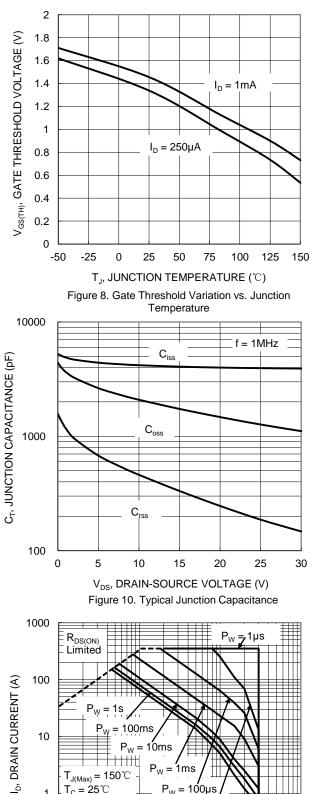
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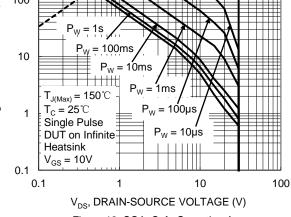
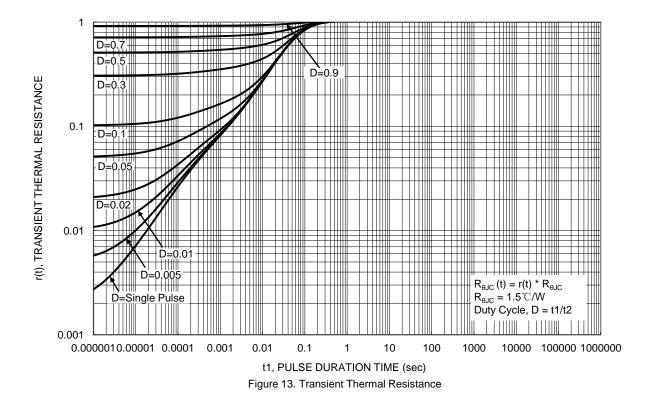


Figure 12. SOA, Safe Operation Area

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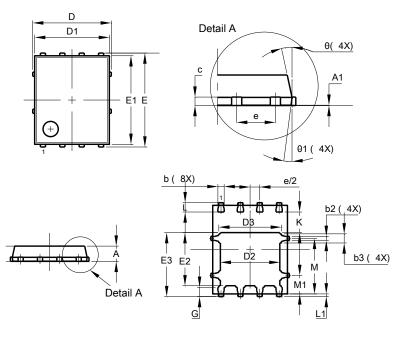




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

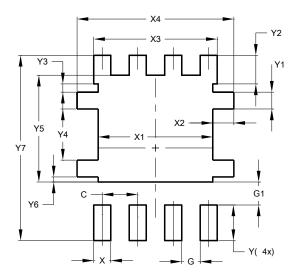


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(6.15 BSC			
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е		1.27 BSC			
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All	All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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